Dual INT-A-PAK Low Profile “Half Bridge” (Trench PT IGBT), 300 A

Proprietary Vishay IGBT Silicon “L Series”



Dual INT-A-PAK Low Profile

PRIMARY CHARACTERISTICS	
V_{CES}	600 V
I_C DC at T_C = 104 °C	300 A
$V_{CE(on)}$ (typical) at 300 A, 25 °C	1.30 V
Speed	DC to 1 kHz
Package	Dual INT-A-PAK low profile
Circuit configuration	Half bridge

FEATURES

- Trench PT IGBT technology
- Low $V_{CE(on)}$
- Square RBSOA
- HEXFRED® antiparallel diode with ultrasoft reverse recovery characteristics
- Industry standard package
- Al_2O_3 DBC
- UL approved file E78996
- Designed for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT

BENEFITS

- Increased operating efficiency
- Performance optimized as output inverter stage for TIG welding machines
- Direct mounting on heatsink
- Very low junction to case thermal resistance

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MAX.**	**UNITS**
Collector to emitter voltage	V_{CES}		600	V
Continuous collector current	I_C (1)	T_C = 25 °C	580	A
		T_C = 80 °C	400	
Pulsed collector current	I_{CM}		800	
Clamped inductive load current	I_{LM}		800	
Diode continuous forward current	I_F	T_C = 25 °C	219	
		T_C = 80 °C	145	
Gate to emitter voltage	V_{GE}		± 20	V
Maximum power dissipation (IGBT)	P_D	T_C = 25 °C	1136	W
		T_C = 80 °C	636	
RMS isolation voltage	V_{ISOL}	Any terminal to case (V_{RMS} t = 1 s, T_J = 25 °C)	3500	V
Operating junction and storage temperature range	T_J, T_{Stg}		-40 to +150	°C

Note

(1) Maximum continuous collector current must be limited to 500 A to do not exceed the maximum temperature of terminals

For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

ELECTRICAL SPECIFICATIONS (T_J = 25 °C unless otherwise specified)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNITS**
Collector to emitter breakdown voltage	$V_{BR(CES)}$	V_{GE} = 0 V, I_C = 500 µA	600	-	-	V
Collector to emitter voltage	$V_{CE(on)}$	V_{GE} = 15 V, I_C = 150 A	-	1.12	1.21	
		V_{GE} = 15 V, I_C = 300 A	-	1.30	1.45	
		V_{GE} = 15 V, I_C = 150 A, T_J = 125 °C	-	1.03	-	
		V_{GE} = 15 V, I_C = 300 A, T_J = 125 °C	-	1.26	-	
Gate threshold voltage	$V_{GE(th)}$	V_{CE} = V_{GE}, I_C = 6.4 mA	4.9	6.0	8.8	
		V_{CE} = V_{GE}, I_C = 6.4 mA, T_J = 125 °C	-	3.4	-	
Temperature coefficient of threshold voltage	$\Delta V_{GE(th)}/\Delta T$	V_{CE} = V_{GE}, I_C = 6.4 mA, (25 °C to 125 °C)	-	-26	-	mV/°C
Forward transconductance	g_{fe}	V_{CE} = 20 V, I_C = 50 A	-	67	-	S
Transfer characteristics	V_{GE}	V_{CE} = 20 V, I_C = 300 A	-	11.4	-	V
Collector to emitter leakage current	I_{CES}	V_{GE} = 0 V, V_{CE} = 600 V	-	4.0	150	µA
		V_{GE} = 0 V, V_{CE} = 600 V, T_J = 125 °C	-	100	-	
Diode forward voltage drop	V_{FM}	I_{FM} = 150 A	-	1.31	1.41	V
		I_{FM} = 300 A	-	1.56	1.75	
		I_{FM} = 150 A, T_J = 125 °C	-	1.28	-	
		I_{FM} = 300 A, T_J = 125 °C	-	1.63	-	
Gate to emitter leakage current	I_{GES}	V_{GE} = ± 20 V	-	-	± 500	nA

SWITCHING CHARACTERISTICS (T_J = 25 °C unless otherwise specified)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNITS**
Turn-on switching energy	E_{on}	I_C = 300 A, V_{CC} = 300 V, V_{GE} = 15 V, R_g = 1.5 Ω, L = 500 µH, T_J = 25 °C	-	6.0	-	mJ
Turn-off switching energy	E_{off}		-	33	-	
Total switching energy	E_{tot}		-	39	-	
Turn-on delay time	$t_{d(on)}$		-	503	-	ns
Rise time	t_r		-	214	-	
Turn-off delay time	$t_{d(off)}$		-	600	-	
Fall time	t_f		-	547	-	
Turn-on switching loss	E_{on}	I_C = 300 A, V_{CC} = 300 V, V_{GE} = 15 V, R_g = 1.5 Ω, L = 500 µH, T_J = 125 °C	-	7.2	-	mJ
Turn-off switching loss	E_{off}		-	55.2	-	
Total switching loss	E_{tot}		-	62.4	-	
Turn-on delay time	$t_{d(on)}$		-	476	-	ns
Rise time	t_r		-	209	-	
Turn-off delay time	$t_{d(off)}$		-	807	-	
Fall time	t_f		-	918	-	
Reverse bias safe operating area	RBSOA	T_J = 150 °C, I_C = 800 A, V_{CC} = 300 V V_P = 600 V, R_g = 1.5 Ω, V_{GE} = 15 V to 0 V, L = 500 µH	Fullsquare			
Diode reverse recovery time	t_{rr}	I_F = 300 A, R_g = 1.5 Ω, V_{CC} = 300 V, T_J = 25 °C	-	119	-	ns
Diode peak reverse current	I_{rr}		-	99	-	A
Diode recovery charge	Q_{rr}		-	7.3	-	µC
Diode reverse recovery time	t_{rr}	I_F = 300 A, R_g = 1.5 Ω, V_{CC} = 300 V, T_J = 125 °C	-	165	-	ns
Diode peak reverse current	I_{rr}		-	127	-	A
Diode recovery charge	Q_{rr}		-	13	-	µC

For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER			SYMBOL	MIN.	TYP.	MAX.	UNITS
Operating junction and storage temperature range			T_J, T_{Stg}	-40	-	150	°C
Junction to case per leg		IGBT	R_{thJC}	-	-	0.11	°C/W
		diode		-	-	0.4	
Case to sink per module			R_{thCS}	-	0.05	-	
Mounting torque	case to heatsink: M6 screw			4	-	6	Nm
	case to terminal 1, 2, 3: M5 screw			2	-	5	
Weight				-	270	-	g

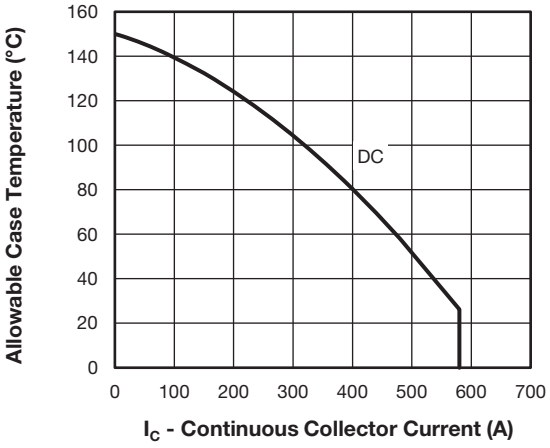


Fig. 1 - Maximum IGBT Continuous Collector Current vs. Case Temperature

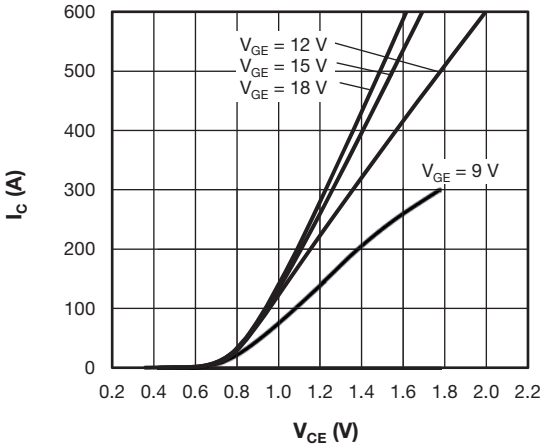


Fig. 3 - Typical IGBT Output Characteristics, T_J = 125 °C

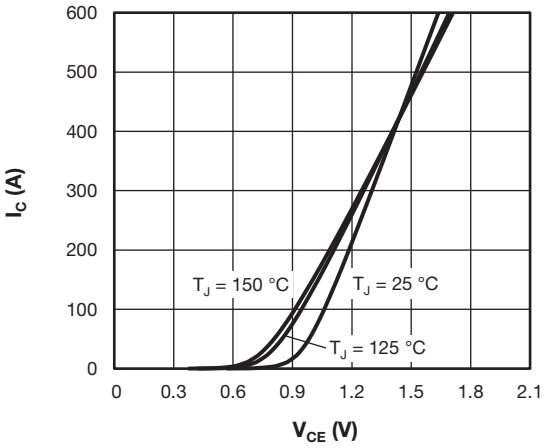


Fig. 2 - Typical IGBT Output Characteristics, V_{GE} = 15 V

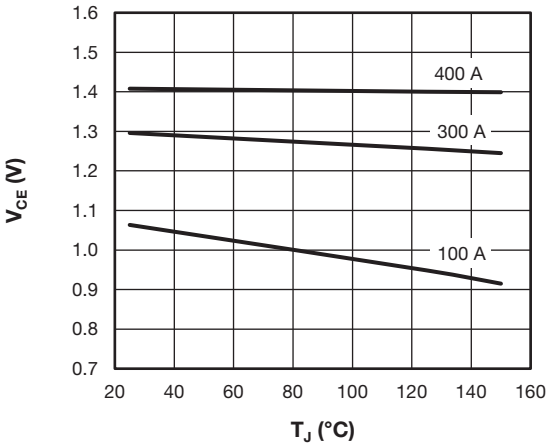


Fig. 4 - Collector to Emitter Voltage vs. Junction Temperature

For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

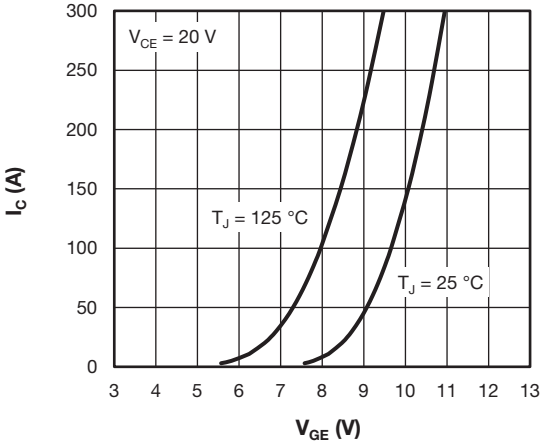


Fig. 5 - Typical IGBT Transfer Characteristics

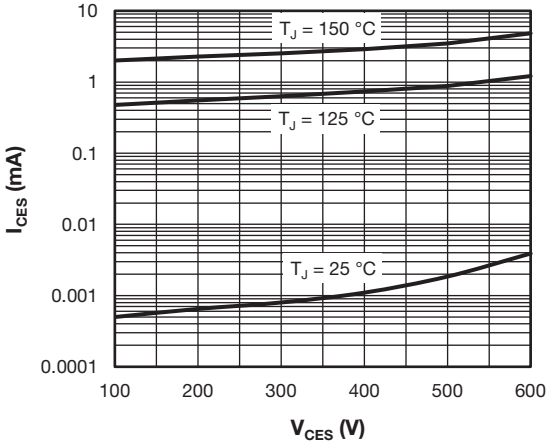


Fig. 8 - Typical IGBT Zero Gate Voltage Collector Current

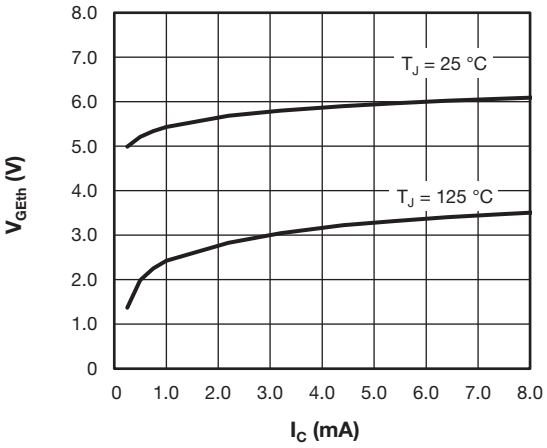


Fig. 6 - Typical IGBT Gate Threshold Voltage

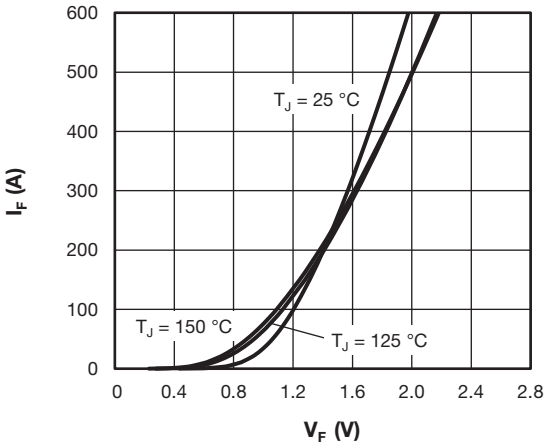


Fig. 9 - Typical Diode Forward Characteristics

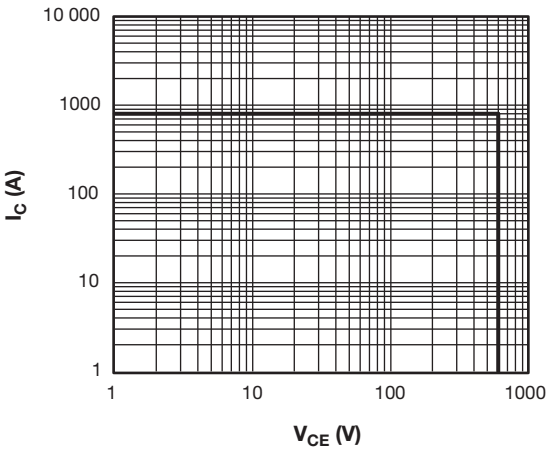


Fig. 7 - IGBT Reverse BIAS SOA T_J = 150 °C, V_{GE} = 15V

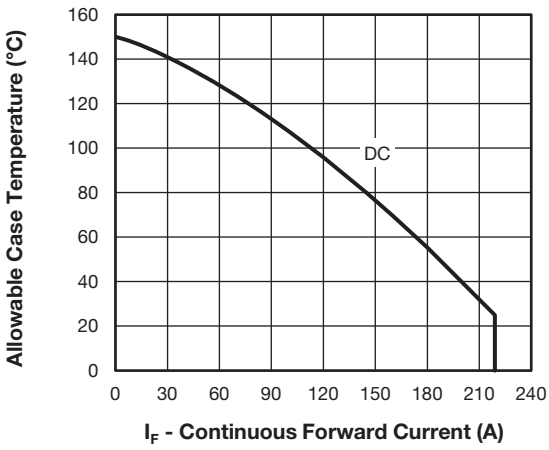


Fig. 10 - Maximum Diode Continuous Forward Current vs. Case Temperature

For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

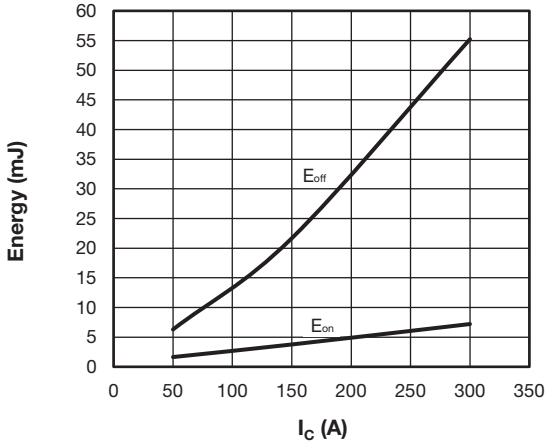


Fig. 11 - Typical IGBT Energy Loss vs. I_C
T_J = 125 °C, V_{CC} = 300 V, R_g = 1.5 Ω, V_{GE} = 15 V, L = 500 µH

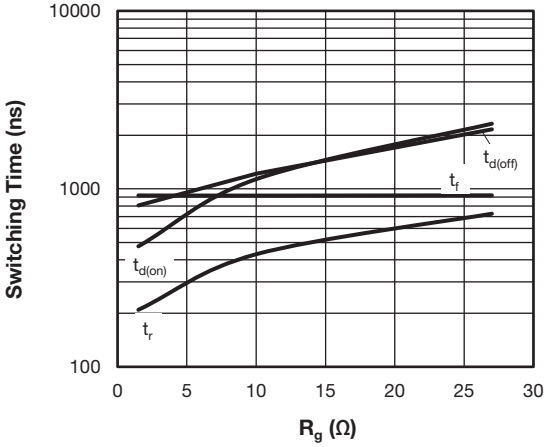


Fig. 14 - Typical IGBT Switching Time vs. R_g
T_J = 125 °C, V_{CC} = 300 V, I_C = 300 A, V_{GE} = 15 V, L = 500 µH

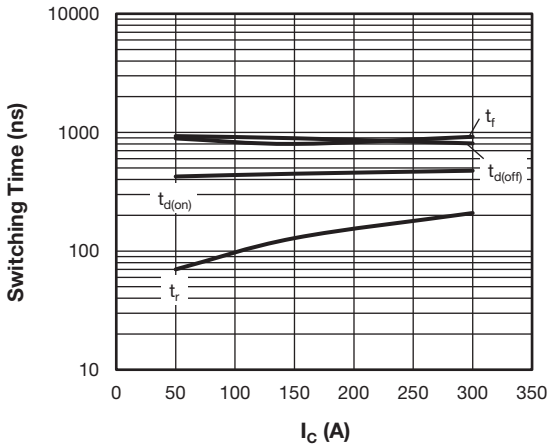


Fig. 12 - Typical IGBT Switching Time vs. I_C
T_J = 125 °C, V_{CC} = 300 V, R_g = 1.5 Ω, V_{GE} = 15 V, L = 500 µH

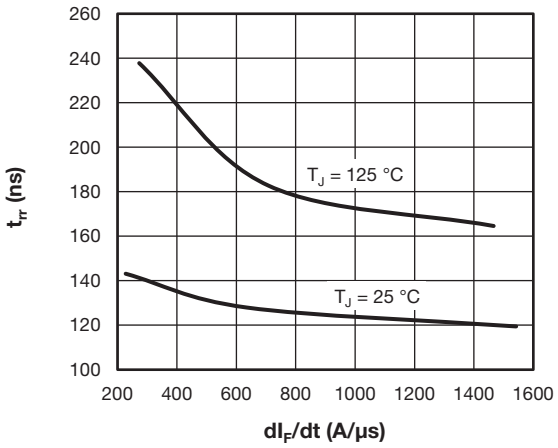


Fig. 15 - Typical Diode Reverse Recovery Time vs. dI_F/dt
V_{CC} = 300 V, I_F = 300 A

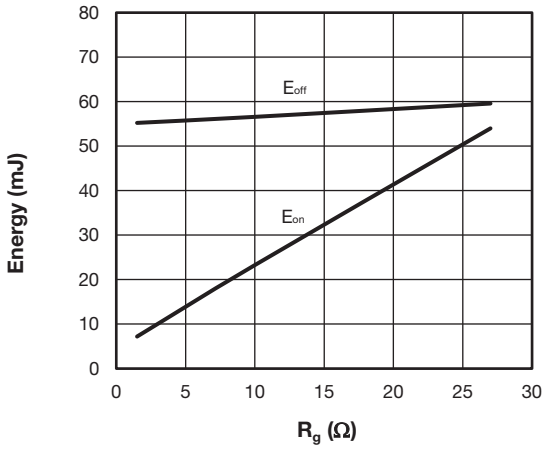


Fig. 13 - Typical IGBT Energy Loss vs. R_g
T_J = 125 °C, V_{CC} = 300 V, I_C = 300 A, V_{GE} = 15 V, L = 500 µH

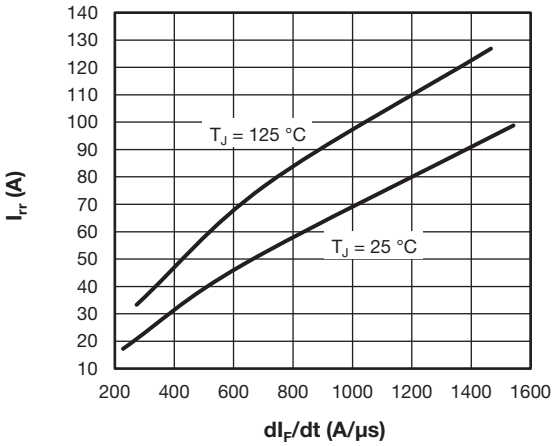


Fig. 16 - Typical Diode Reverse Recovery Current vs. dI_F/dt
V_{CC} = 300 V, I_F = 300 A

For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

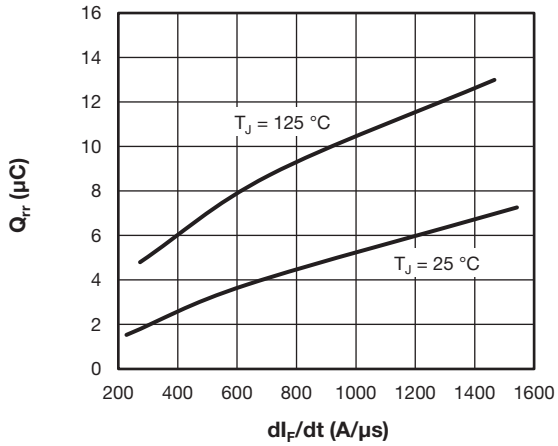


Fig. 17 - Typical Diode Reverse Recovery Charge vs. dI_F/dt
V_{CC} = 300 V, I_F = 300 A

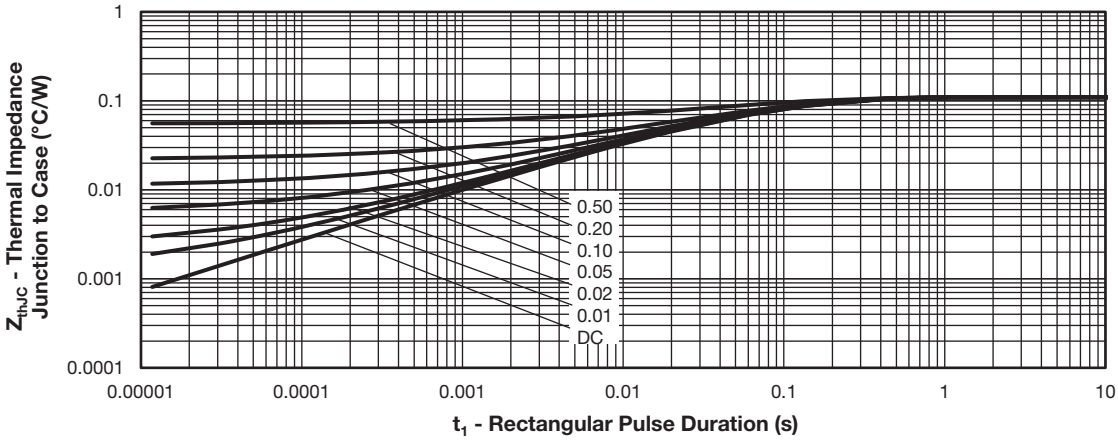


Fig. 18 - Maximum Thermal Impedance Z_{thJC} Characteristics - (IGBT)

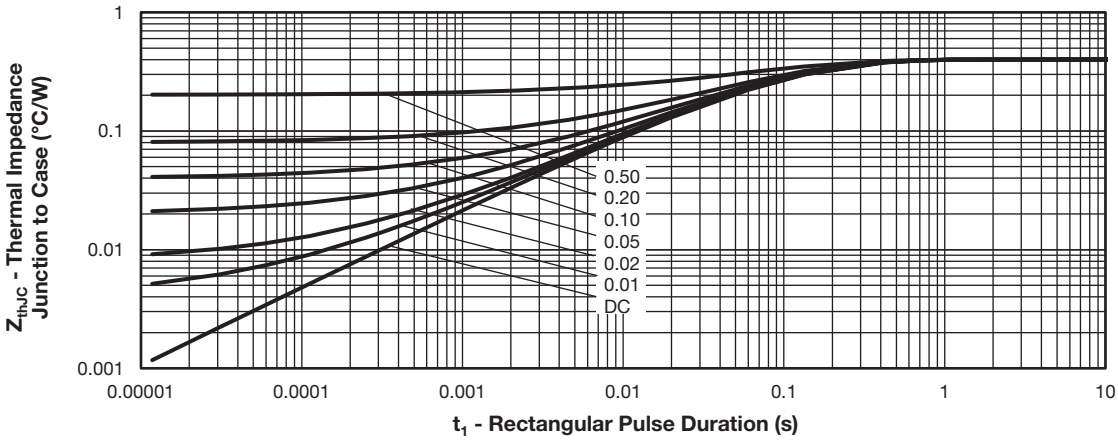


Fig. 19 - Maximum Thermal Impedance Z_{thJC} Characteristics - (Diode)

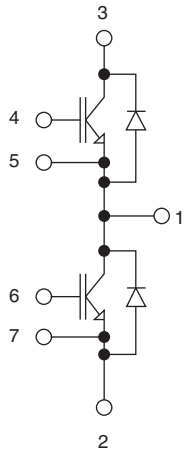
For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

ORDERING INFORMATION TABLE

Device code	VS-	G	P	300	T	D	60	S
	1	2	3	4	5	6	7	8

- 1 - Vishay Semiconductors product
- 2 - Insulated gate bipolar transistor (IGBT)
- 3 - Trench PT IGBT technology
- 4 - Current rating (300 = 300 A)
- 5 - Circuit configuration (T = half bridge)
- 6 - Package indicator (D = dual INT-A-PAK low profile)
- 7 - Voltage rating (60 = 600 V)
- 8 - Speed / type (S = standard speed IGBT)

CIRCUIT CONFIGURATION

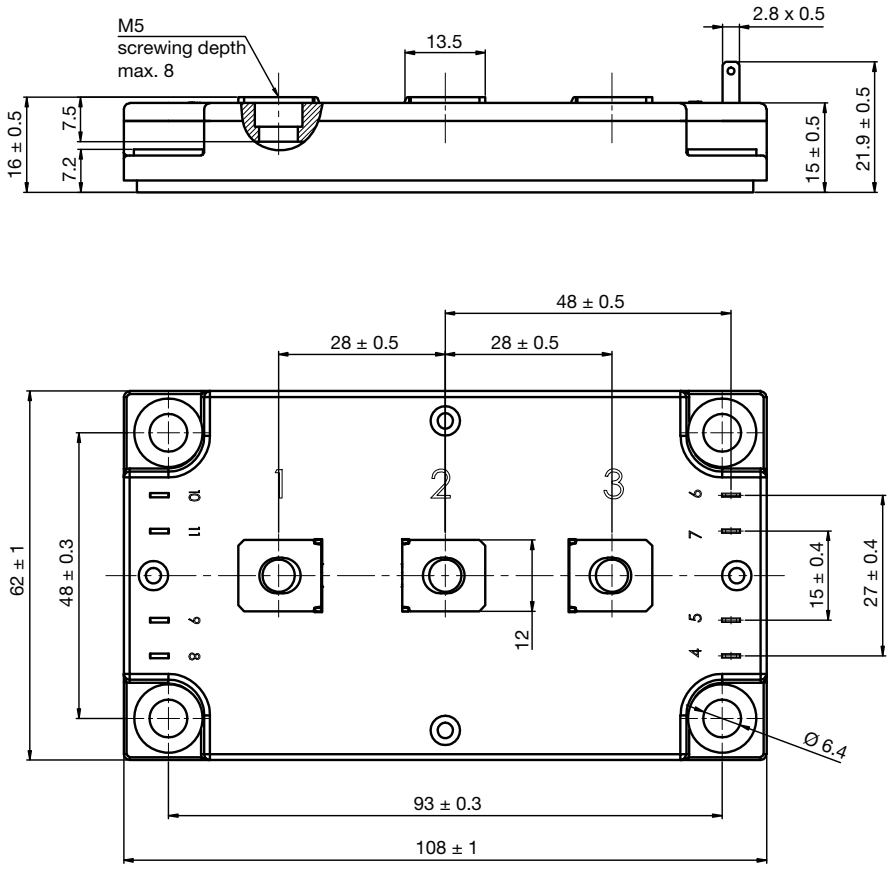


LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95435

For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

Dual INT-A-PAK Low Profile

DIMENSIONS in millimeters



For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, “Vishay”), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

© 2022 VISHAY INTERTECHNOLOGY, INC. ALL RIGHTS RESERVED